

## S3016 ultra



Powerful 3D sensor technology for quality control from below

Shadow-free results by using eight angled cameras

Versatile handling of many very different inspection object types

Optional return transport of the manufactured products

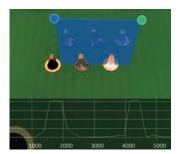
## 3D Solder Joint Inspection on PCB Bottom Sides

With this machine type, Viscom brings its great THT competence into line with its longstanding experience in developing high-quality 3D inspection systems for SMD production. The S3016 *ultra* is perfectly suited for inspecting SMD, THT and pressfit components as well as selective solder joints from below. THT solder joints, for example, can be precisely inspected in 3D with intelligent, high-throughput inspection technology from Viscom.

The S3016 *ultra* is easily and efficiently combinable with a Viscom verification station. Results can be conveniently evaluated with data and images from other Viscom inspection stages. Implementing an efficient statistical process control from Viscom is also an option.

Even under extreme cycle time requirements, the system's high-performance camera technology ensures the greatest inspection depth. Versatile illuminations can be tuned to the specific task. Previously captured images are evaluated at the same time an x/y unit moves the camera module beneath the printed circuit board to the next position – a decisive time advantage.

In addition to measuring pins, Viscom inspection algorithms also enable fast detection of open solder joints, solder bridges, missing pins and other defects.



Reliable 3D inspection of THT solder joints



Insufficient wetting (front) and missing pin (back)

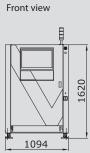


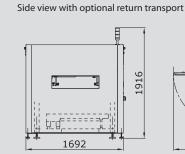


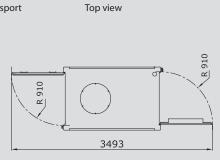


## **Technical Specifications**









Dimensions in mm

|                   |                             | S3016 ultra  |
|-------------------|-----------------------------|--|
| Inspection scope  | 3D AOI                      | Selective and wave soldering, standard solder joints according to IPC, press fit |
|                   |                             |  |
| Camera technology | 3D camera technology        |  |
|                   | Z-resolution                | 0.5 μm   |
|                   | Z-range                     | Up to 30 mm (1.2")   |
|                   | Angled view cameras         |  |
|                   | Number of megapixel cameras | 8  |
|                   | Orthogonal camera           |  |
|                   | Resolution                  | 15 μm  |
|                   | Field of view               | 50 mm x 50 mm (2" x 2")  |
| Software          | User interface              | Viscom EasyPro/vVision-ready   |
|                   | Statistical process control | Viscom SPC/vSPC, open interface (optional)                                       |
|                   | Verification station        | Viscom HARAN/vVerify   |
|                   | Remote diagnosis            | Viscom SRC (software remote control) (optional)                                  |
|                   | Programming station         | Viscom PST34 (optional)  |
| System computer   | Operating system            | Windows®   |
|                   | Processor                   | Intel® Core™ i7  |
| PCB handling      | Transport type              | Single track transport, return transport (optional)                              |
|                   | PCB dimensions (L x W)      | 520 mm x 610 mm, minimum width 70 mm (19.7" x 19.7", min. width 2.8")            |
|                   | Transport height            | 950 - 1000 mm ± 20 mm* (37.4" - 39.4" ± 0.8");                                   |
|                   |                             | optional return transport: up to 300 mm (11.8")                                  |
|                   | Width adjustment            | Automatic  |
|                   | Upper transport clearance   | Up to 80 mm (3.1")*  |
|                   | Lower transport clearance   | Up to 50 mm (2")   |
| Inspection speed  |                             | Up to 65 cm <sup>2</sup> /s  |
|                   |                             |  |
| Other system data | Positioning/handling unit   | Synchronous linear motors  |
|                   | Interfaces                  | SMEMA  |
|                   | Power requirements          | 400 V (other voltages on request), 3P/N/PE, 8 A, 4 - 6 bar working pressure      |
|                   | System dimensions           | 1094 mm x 1620 mm x 1692 mm (43.1" x 63.8" x 66.6") (W x H x D)                  |
|                   | Weight                      | 750 kg (1653 lbs)  |

<sup>\*</sup>Standard configuration, individual adjustments on request